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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Rodney C. Langley

Serial No.: 09/438,692 ✓

Filed: November 11, 1999

For: SEMICONDUCTOR DEVICE WITH
IMPROVED BOND PADS

Examiner: R. Potter

Group Art Unit: 2822

Attorney Docket No.: 3656US
(95-0028-RE)

CERTIFICATE OF MAILING

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AMENDMENT

Box Non Fee Amendment
Commissioner for Patents
Washington, D.C. 20231

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed October 17, 2001, the three-month shortened statutory period for response to which expires on January 17, 2002.

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